

# STPS20SM80C

# Power Schottky rectifier

## Features

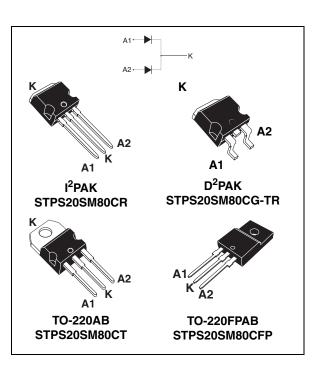
- High junction temperature capability
- Optimized trade-off between leakage current and forward voltage drop
- Low leakage current
- Avalanche capability specified
- Insulated package TO-220FPAB
  - insulated voltage: 2000 V
  - package capacitance: 45 pF

## Description

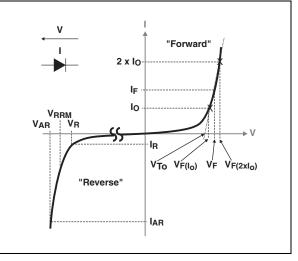
This dual diode Schottky rectifier is suited for high frequency switch mode power supply.

Packaged in TO-220AB, I<sup>2</sup>PAK, D<sup>2</sup>PAK and TO-220FPAB, this device is particularly suited for use in notebook, game station, LCD TV and desktop adapters, providing these applications with a good efficiency at both low and high load.

Symbol	Value
I <sub>F(AV)</sub>	2 x 10 A
V <sub>RRM</sub>	80 V
T <sub>j</sub> (max)	175 °C
V <sub>F</sub> (typ)	515 mV







a. V<sub>ARM</sub> and I<sub>ARM</sub> must respect the reverse safe operating area defined in *Figure 13*. V<sub>AR</sub> and I<sub>AR</sub> are pulse measurements (t<sub>p</sub> < 1 µs). V<sub>R</sub>, I<sub>R</sub>, V<sub>RRM</sub> and V<sub>F</sub>, are static characteristics

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# 1 Characteristics

# Table 2.Absolute ratings (limiting values, per diode, at T<sub>amb</sub> = 25 °C unless<br/>otherwise specified)

Symbol	Parameter					Unit
V <sub>RRM</sub>	Repetitive peak reverse volt	tage			80	V
I <sub>F(RMS)</sub>	Forward rms current				30	А
	Average forward current,	TO-220AB, I <sup>2</sup> PAK, D <sup>2</sup> PAK	T <sub>c</sub> = 155 °C T <sub>c</sub> = 150 °C	Per diode Per device	10 20	٨
I <sub>F(AV)</sub>	$\delta = 0.5$	TO-220FPAB	$T_c = 130 \ ^\circ C$ $T_c = 100 \ ^\circ C$		10 20	A
I <sub>FSM</sub>	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal}$ $T_c = 25 \text{ °C}$			220	А
P <sub>ARM</sub> <sup>(1)</sup>	Repetitive peak avalanche	power	$T_j = 25 \ ^\circ C, t_p$	= 1 µs	5400	W
V <sub>ARM</sub> <sup>(2)</sup>	Maximum repetitive peak avalanche voltage	t <sub>p</sub> < 1 μs, T <sub>j</sub> < 1	t <sub>p</sub> < 1 μs, T <sub>j</sub> < 150 °C, I <sub>AR</sub> < 16.2 A			V
V <sub>ASM</sub> <sup>(2)</sup>	Maximum single pulse peak avalanche voltage	t <sub>p</sub> < 1 μs, T <sub>j</sub> < 150 °C, I <sub>AR</sub> < 16.2 A			100	V
T <sub>stg</sub>	Storage temperature range	age temperature range			-65 to +175	°C
Тj	Maximum operating junction	n temperature <sup>(3)</sup>	)		175	°C

 For temperature or pulse time duration deratings, please refer to figure 3 and 4. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the application notes AN1768 and AN2025.

2. See Figure 13

3.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

#### Table 3.Thermal parameters

Symbol	Parameter			Value	Unit
	TO-220AB		per diode	2.30	
Б		I <sup>2</sup> PAK, D <sup>2</sup> PAK	total	1.55	°C/W
R <sub>th(j-c)</sub>			per diode	5.80	C/VV
		TU-220FPAD	total	4.65	
R <sub>th(c)</sub>	Coupling	TO-220AB I <sup>2</sup> PAK, D <sup>2</sup> PAK	- <b>-</b>	0.80	°C/W
	TO-220FPAB			3.50	

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_{j}$ (diode 1) = P(diode 1) x R<sub>th(j-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>



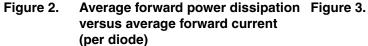
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
ا <sub>B</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V - V	-	5.8	25	μA
'R` ′	$T_j = 125 \text{ °C}$	$T_j = 125 \degree C$ $V_R = V_{RRM}$	-	5	15	mA	
		T <sub>j</sub> = 25 °C	1 - 5 4	-	0.590	0.640	
	<sup>2)</sup> Forward voltage drop	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 5 A	-	0.515	0.550	
Ve <sup>(2)</sup>		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A	-	0.710	0.780	v
۷F		T <sub>j</sub> = 125 °C	F = 10 A	-	0.595	0.650	v
		T <sub>j</sub> = 25 °C	L = 20 A	-	0.850	0.945	
		T <sub>i</sub> = 125 °C	I <sub>F</sub> = 20 A	-	0.690	0.780	

Table 4. Static electrical characteristics (per diode)

1. Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %

2. Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2 \ \%$ 

To evaluate the conduction losses use the following equation: P = 0.52 x  $I_{F(AV)}$  + 0.013 x  ${I_F}^2_{(RMS)}$ 



Average forward current versus ambient temperature ( $\delta = 0.5$ , per diode)

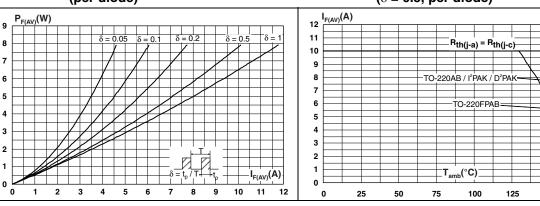
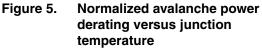
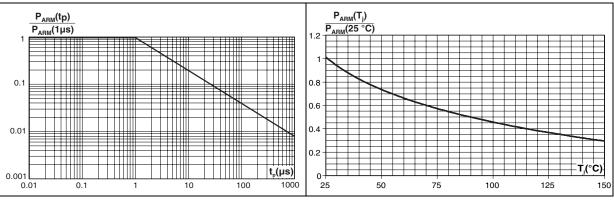


Figure 4. Normalized avalanche power derating versus pulse duration



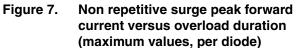


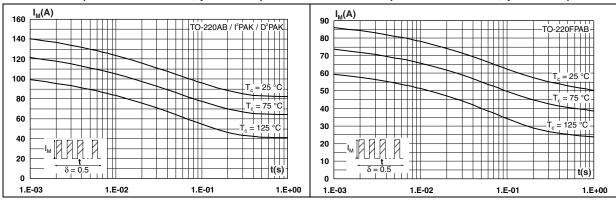
57

150

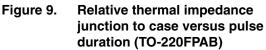
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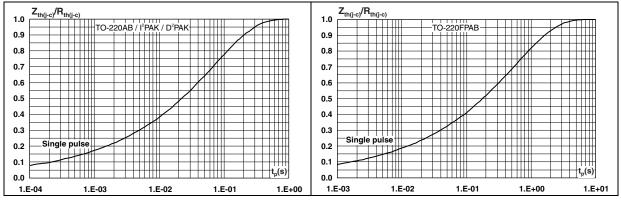
# Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values, per diode)





# Figure 8. Relative thermal impedance junction to case versus pulse duration





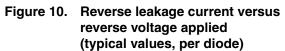
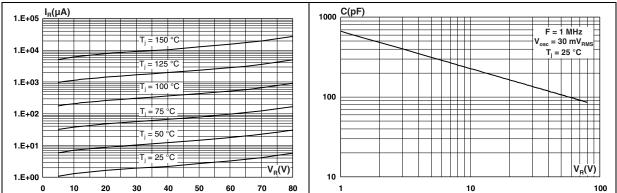
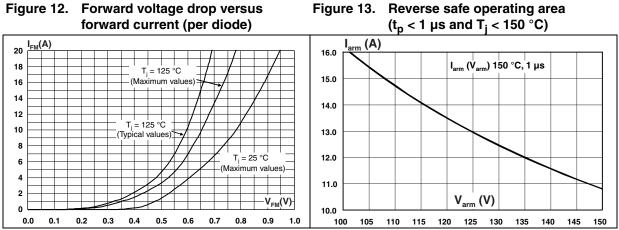


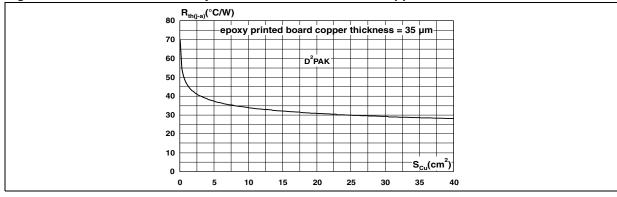
Figure 11. Junction capacitance versus reverse voltage applied (typical values, per diode)







#### Figure 14. Thermal resistance junction to ambient versus copper surface under tab for D<sup>2</sup>PAK



# 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 5. TO-220AB dimensions

			Dimer	nsions	
	Ref.	Millin	neters	Inc	hes
		Min.	Max.	Min.	Max.
	А	4.40	4.60	0.173	0.181
	С	1.23	1.32	0.048	0.051
H2 A Dia C.	D	2.40	2.72	0.094	0.107
	E	0.49	0.70	0.019	0.027
	F	0.61	0.88	0.024	0.034
	F1	1.14	1.70	0.044	0.066
	F2	1.14	1.70	0.044	0.066
	G	4.95	5.15	0.194	0.202
$ \downarrow F1 \rightarrow \downarrow $	G1	2.40	2.70	0.094	0.106
	H2	10	10.40	0.393	0.409
F→ ←	L2	16.4	Тур.	0.645	5 Тур.
	L4	13	14	0.511	0.551
	L5	2.65	2.95	0.104	0.116
G	L6	15.25	15.75	0.600	0.620
	L7	6.20	6.60	0.244	0.259
	L9	3.50	3.93	0.137	0.154
	М	2.6	Тур.	0.102	2 Тур.
	Dia.	3.75	3.85	0.147	0.151



			Dimer	nsions	
	Ref.	Millin	neters	Inc	hes
		Min.	Max.	Min.	Max.
	Α	4.4	4.9	0.173	0.192
	В	2.5	2.9	0.098	0.114
	D	2.45	2.75	0.096	0.108
	Е	0.4	0.7	0.016	0.028
	F	0.6	1	0.024	0.039
	F1	1.15	1.7	0.045	0.067
	F2	1.15	1.7	0.045	0.067
	G	4.95	5.2	0.195	0.205
	G1	2.4	2.7	0.094	0.106
	Н	10	10.7	0.394	0.421
	L2	16	Тур.	0.630	) Тур.
	L3	28.6	30.6	1.126	1.205
G	L4	9.8	10.7	0.386	0.421
	L6	15.8	16.4	0.622	0.646
	L7	9	9.9	0.354	0.390
	Dia.	2.9	3.5	0.114	0.138

Table 6. TO-220FPAB dimensions



			Dimer	nsions	
	Ref.	Millin	neters	Inc	hes
		Min.	Max.	Min.	Max.
	А	4.40	4.60	0.173	0.181
	A1	2.49	2.69	0.098	0.106
$\begin{array}{c c} L2 \\ \hline \\ $	A2	0.03	0.23	0.001	0.009
	В	0.70	0.93	0.027	0.037
	• • B2	1.14	1.70	0.045	0.067
	C	0.45	0.60	0.017	0.024
	C2	1.23	1.36	0.048	0.054
$ \begin{array}{c} B2 \\ \hline B \\ \hline B \\ \hline \end{array} \end{array} $	D	8.95	9.35	0.352	0.368
G	E	10.00	10.40	0.393	0.409
A2	G	4.88	5.28	0.192	0.208
	L	15.00	15.85	0.590	0.624
M (*)	V2 L2	1.27	1.40	0.050	0.055
* FLAT ZONE NO LESS	L3	1.40	1.75	0.055	0.069
	M	2.40	3.20	0.094	0.126
	R	0.40	typ.	0.01	6 typ.
	V2	0°	8°	0°	8°





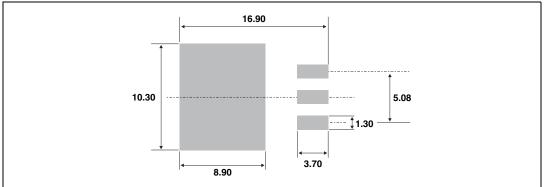


Table 6. I FAR differis				Dimer	sions				
				Ref.	Millin	neters	Inc	hes	
i			Min.	Max.	Min.	Max.			
		А	4.40	4.60	0.173	0.181			
		A1	2.40	2.72	0.094	0.107			
		b	0.61	0.88	0.024	0.035			
	D	b1	1.14	1.70	0.044	0.067			
		С	0.49	0.70	0.019	0.028			
		c2	1.23	1.32	0.048	0.052			
		D	8.95	9.35	0.352	0.368			
		е	2.40	2.70	0.094	0.106			
		e1	4.95	5.15	0.195	0.203			
	→ C	E	10	10.40	0.394	0.409			
l e1 →		L	13	14	0.512	0.551			
		L1	3.50	3.93	0.138	0.155			
		L2	1.27	1.40	0.050	0.055			

### Table 8.I<sup>2</sup>PAK dimensions



# **3** Ordering information

### Table 9.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS20SM80CT	PS20SM80CT	TO-220AB	1.9 g	50	Tube
STPS20SM80CFP	PS20SM80CFP	TO-220FPAB	2.0 g	50	Tube
STPS20SM80CR	PS20SM80CR	I <sup>2</sup> PAK	1.49 g	50	Tube
STPS20SM80CG-TR	PS20SM80CG	D <sup>2</sup> PAK	1.48 g	1000	Tape and reel

# 4 Revision history

Table 10.	Revision	history
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Date	Revision	Changes
11-Apr-2011	1	First issue.



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